

PATENT ASSIGNMENT

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SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tsuyoshi Nakamura	01/18/2008
Yasuhiko Kitano	01/18/2008
Yoshimitsu Ishihara	01/18/2008
Shingo Maeda	01/18/2008

RECEIVING PARTY DATA

Name:	HONDA MOTOR CO., LTD.
Street Address:	1-1, Minami-Aoyama 2-chome
Internal Address:	Minato-ku
City:	tokyo
State/Country:	JAPAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12025204

CORRESPONDENCE DATA

Fax Number: (216)566-9711

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Correspondent Name: Rankin Hill and Clark

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ATTORNEY DOCKET NUMBER:

18064

NAME OF SUBMITTER:

David E. Spaw

Total Attachments: 2

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PATENT

REEL: 020459 FRAME: 0603

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OP \$40.00 12025204

ASSIGNMENT

WHEREAS, new and useful improvements have been made by the undersigned
in PRESS FORMING DIE SET AND METHOD

that are the subject of an application for a U.S. Patent, (Application No. 12/025204,
filed 02/04/2008), which application is further identified as Rankin, Hill,
Porter & Clark LLP Docket No. SHM-18064.

WHEREAS, Honda Motor Co., Ltd., a corporation of Japan, and having a
place of business at 1-1, Minami-Aoyama 2-chome, Minato-ku, Tokyo, Japan,
hereinafter referred to as "assignee", is desirous of acquiring all right, title, and interest
throughout the world in, to, and under said improvements and inventions and patent
rights therefor.

NOW, THEREFORE, be it known that, for valuable consideration, the receipt
and sufficiency of which are hereby acknowledged, all right, title, and interest, in the
United States and throughout the world, in, to and under said improvements and
inventions and all patents, patent applications, patent rights, and inventor's certificates
thereof, therefor, and therein, including without limitation said application for patent in
the United States, all divisions and continuations thereof, all patents which may be
granted thereon, all reissues and extensions thereof, all right to sue for past
infringement thereunder, all patents which may be granted for said improvements and
inventions by states or nations other than the United States, or by other authority,
entity, or organization, and all applications therefor, have been and are hereby sold,
assigned, transferred, and delivered unto assignee, its successors and assigns; and it
is covenanted and agreed by the undersigned, and for executors, administrators, and
legal representatives of the undersigned, that at assignee's request any and all
applications, affidavits, assignments, and other instruments will be made, executed,
and delivered as may be necessary, or desirable to secure for or vest in assignee, its
successors or assigns, any improvement, inventions, right, title, interest, application,
patent, patent right or other right or property covered by this assignment, and the
United States Commissioner of Patents and Trademarks is hereby requested and
authorized to issue any and all United States patents granted on any of said
applications to assignee as owner of the entire right, title, and interest in, to, and under
the same, and appropriately empowered officials of foreign countries are hereby
authorized to issue any letters patent granted on any of said applications to assignee
as owner of the entire right, title and interest in, to, and under the same.

The undersigned hereby grants the firm of Rankin, Hill, Porter & Clark LLP the
power to insert on this assignment any identification that may be necessary or
desirable in order to comply with the rules of the United States Patent and Trademark
Office for recordation of this document.

IN WITNESS WHEREOF, this assignment has been executed below by the undersigned:

- (1) Inventor Name (sole or joint): Tsuyoshi NAKAMURA

Signature: Tsuyoshi Nakamura

Today's Date : January 18, 2008

Witness: Keiichi Takemoto

Witness: Hideki Sugawara

- (2) Inventor Name (sole or joint): Yasuhiko KITANO

Signature: Yasuhiko Kitano

Today's Date : January 18, 2008

Witness: Keiichi Takemoto

Witness: Hideki Sugawara

- (3) Inventor Name (sole or joint): Yoshimitsu ISHIHARA

Signature: Yoshimitsu Ishihara

Today's Date : January 18, 2008

Witness: Keiichi Takemoto

Witness: Hideki Sugawara

- (4) Inventor Name (sole or joint): Shingo MAEDA

Signature: Shingo Maeda

Today's Date : January 18, 2008

Witness: Keiichi Takemoto

Witness: Hideki Sugawara